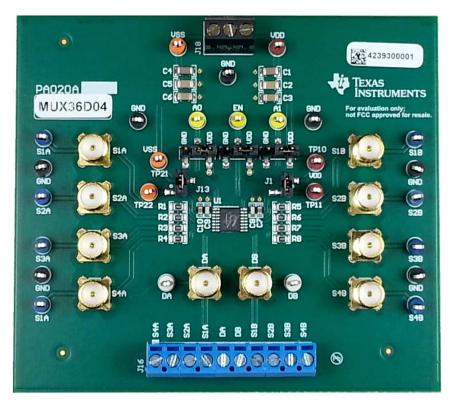


MUX36D04EVM-PDK



This user guide describes the characteristics, operation, and use of the MUX36D04 evaluation module (EVM) performance demonstration kit (PDK). This kit is an evaluation platform for MUX36D04, an analog multiplexer (mux) that offers 4:1 differential or 8:2 single-ended channels. This user guide includes setup and operating instructions, complete circuit descriptions, schematic diagrams, printed circuit board (PCB) layout, and a bill of materials (BOM).

NOTE: The MUX36D04EVM may also be used to evaluate the performance of the MUX509 as the two parts are pin compatible. The MUX509 would have to be separately ordered and manually soldered on the MUX36D04EVM.

Throughout this document, the terms MUX36D04EVM, demonstration kit, evaluation board, evaluation module, and EVM are synonymous with the MUX36D04EVM-PDK.

The following related documents are available through the Texas Instruments web site at www.ti.com.

Related Documentation

| Device | Literature Number |
|----------|-------------------|
| MUX36D04 | SBOS705 |

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1 Overview

The MUX36D04 is a CMOS analog multiplexer that offers 4:1 differential or 8:2 single-ended channels, operates with either dual supplies (±5 V to ±18 V) or a single supply (10 V to 36 V), and supports true rail-to-rail input and output. The MUX36D04 has very low on- and off-leakage currents and low quiescent current that make it ideally suited for portable applications.

1.1 MUX36D04EVM-PDK Features

The MUX36D04EVM-PDK includes the following features:

- Hardware required for evaluation of the with industry-standard TSSOP package MUX36D04.
- Multiple connectors on input and output pins for ease of evaluation.
- · Layout as per the reference layout in data sheet.
- In addition to basic switching operations, the EVM can be used to test the crosstalk and off-isolation, as per the data sheet.



EVM Setup www.ti.com

2 EVM Setup

This section describes the power supply and jumper configuration options available on the MUX36D04EVM-PDK.

2.1 Powering Up the EVM

The MUX36D04 can operate with either dual supplies (± 5 V to ± 18 V) or a single supply (10 V to 36 V). It can operate with both symmetric supplies (such as $V_{DD} = 12$ V, $V_{SS} = -12$ V), and unsymmetric supplies (such as $V_{DD} = 12$ V, $V_{SS} = -5$ V).

The MUX36D04EVM-PDK provides connections for the power supply pins with either a single or dual power supply, from a minimum $V_{\text{DD}} - V_{\text{SS}}$ range of 10 V to maximum of 36 V. The V_{DD} supply must be connected at pin 1 and V_{SS} at pin 2 of J18 from a tabletop power-supply unit (PSU) as shown in Figure 1. For single-supply operation, connect V_{SS} to GND through a wire-bridge between pin 2 and pin 3 of J18. V_{DD} and V_{SS} can be monitored using TP10 and TP22, respectively.

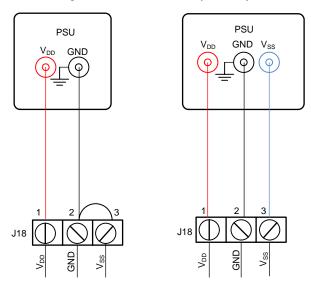


Figure 1. Power Connections for Single Supply (Left) and Dual Supply (Right) Operation

Jumpers J1 and J13 are provided to enable monitoring of the currents drawn from each of these supplies by the MUX36D04 using ammeters. In case ammeters are not used, headers J1 and J13 must be shorted using shunts for normal operation, as listed in Table 1. The EVM ships with these shunts inserted.

Table 1. J1 and J13 Header Description

| Signal | Location | Description | |
|-----------------|--------------------|----------------------------------------|--|
| V _{DD} | J1 pin 1 to pin 2 | Positive power supply for the MUX36D04 | |
| V _{SS} | J13 pin 1 to pin 2 | Negative power supply for the MUX36D04 | |



www.ti.com EVM Setup

2.2 Digital Signal Connections

The digital signals of the MUX36D04 are brought out to headers. Each of these signals can be connected to V_{DD} or V_{SS} by using shunts as listed on Table 2.

Table 2. Digital Signal Locations

| Signal | Location | Description | | |
|--------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| EN | J3 pin 2 | Active high digital input. When this pin is low, all switches are turned off. When this pin is high, the A[2:0] inputs determine which switch is turned on. | | |
| A0 | J4 pin 2 | Address line A0 | | |
| A1 | J5 pin 2 | Address line A1 | | |

Alternatively, these signals may be driven directly from a processor by removing the shunts, and wiring the processor general-purpose I/Os to pin 2 of J3, J4, and J5 jumpers.

2.3 Analog Signal Connections

The analog signals of MUX36D04 are accessible at multiple locations on the MUX36D04EVM-PDK. Table 3 lists all the locations. These signals may be used as input or output signals because the device acts as a switch between the input and output terminals.

Table 3. Analog Signal Locations

| Signal | Header | SMA | Testpoint | Description |
|--------|-----------|-----|-----------|--------------------|
| S1A | J16 pin4 | J2 | TP12 | Source terminal 1A |
| S2A | J16 pin3 | J6 | TP14 | Source terminal 2A |
| S3A | J16 pin2 | J8 | TP18 | Source terminal 3A |
| S4A | J16 pin1 | J10 | TP20 | Source terminal 4A |
| S1B | J16 pin7 | J11 | TP21 | Source terminal 1B |
| S2B | J16 pin8 | J12 | TP24 | Source terminal 2B |
| S3B | J16 pin9 | J14 | TP25 | Source terminal 3B |
| S4B | J16 pin10 | J15 | TP26 | Source terminal 4B |
| DA | NA | J7 | TP17 | Drain terminal A |
| DB | NA | J9 | TP19 | Drain terminal B |



3 Evaluation Using the MUX36D04EVM-PDK

All parameters listed in the specifications table of the MUX36D04 data sheet can be tested on the MUX36D04EVM-PDK.

3.1 Channel Selection Logic

Table 4 provides the truth table for the selection logic for the MUX36D04. This behavior of the device can be evaluated by driving the digital selection signal listed in Section 2.2 to the appropriate levels.

Table 4. Channel Selection Truth Table

| EN | A1 | Α0 | On channel |
|----|------------------|------------------|----------------------|
| 0 | X ⁽¹⁾ | X ⁽¹⁾ | All channels are off |
| 1 | 0 | 0 | Channel 1 |
| 1 | 0 | 1 | Channel 2 |
| 1 | 1 | 0 | Channel 3 |
| 1 | 1 | 1 | Channel 4 |

⁽¹⁾ X denotes don't care..

3.2 Key Specifications

The MUX36D04 datasheet contains detailed information of the test setups for each of the mux parameters. The MUX36D04EVM-PDK can be used to validate these parameters as per the test procedures described in the data sheet.



4 Bill of Materials, PCB Layout, and Schematics

This section contains the MUX36D04EVM-PDK bill of materials (BOM), PCB layout, and EVM schematics.

4.1 Bill of Materials

Table 5 lists the MUX36D04EVM-PDK BOM.

Table 5. Bill of Materials

| Manufacturer Part Number | Qty | Reference Designators | Manufacturer | Description |
|--------------------------|-----|------------------------------------------------|---------------------|-------------------------------------------------------------------------------------------|
| PA020 | 1 | PCB1 | Any | Printed Circuit Board |
| C3216X5R1E476M160AC | 2 | C1, C4 | TDK | CAP, CERM, 47 μF, 25 V, +/- 20%, X5R, 1206 |
| GMK316AB7106KL | 2 | C2, C5 | Taiyo Yuden | CAP, CERM, 10 μF, 35 V, +/- 10%, X7R, 1206 |
| C3216X7R1H105K | 2 | C3, C6 | TDK | CAP, CERM, 1 μF, 50 V, +/- 10%, X7R, 1206 |
| GRM188R72A104KA35D | 2 | C7, C10 | MuRata | CAP, CERM, 0.1 μF, 100 V, +/- 10%, X7R, 0603 |
| C1608C0G2A101J | 2 | C8, C9 | TDK | CAP, CERM, 100 pF, 100 V, +/- 5%, C0G/NP0, 0603 |
| N/A | 3 | FID1, FID2, FID3 | N/A | Fiducial mark. There is nothing to buy or mount. |
| SJ-5303 (CLEAR) | 4 | H1, H2, H3, H4 | 3M | Bumpon, Hemisphere, 0.44 X 0.20, Clear |
| TSM-102-01-L-SV | 2 | J1, J13 | Samtec | Header, 100mil, 2x1, Gold with Tin Tail, SMT |
| 5-1814832-1 | 10 | J2, J6, J7, J8, J9, J10, J11, J12, J14, J15 | TE Connectivity | SMA Straight PCB Socket Die Cast, 50 Ohm, TH |
| TSM-103-01-L-SV | 3 | J3, J4, J5 | Samtec | Header, 100mil, 3x1, Gold, SMT |
| OSTTE100161 | 1 | J16 | On-Shore Technology | Terminal Block, 3.5mm, 10x1, Tin, Blue, TH |
| 39357-0003 | 1 | J18 | Molex | Terminal Block, 3.5 mm, 3x1, Tin, TH |
| THT-14-423-10 | 1 | LBL1 | Brady | Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll |
| ERJ-6GEY0R00V | 8 | R1, R2, R3, R4, R5, R6, R7, R8 | Panasonic | RES, 0, 5%, 0.125 W, 0805 |
| 969102-0000-DA | 5 | SH-J1, SH-J3, SH-J4, SH-J5, SH-J13 | ЗМ | Shunt, 100mil, Gold plated, Black |
| 5005 | 3 | TP1, TP10, TP11 | Keystone | Test Point, Compact, Red, TH |
| 5006 | 7 | TP2, TP3, TP4, TP5, TP6, TP7, TP8 | Keystone | Test Point, Compact, Black, TH |
| 5008 | 3 | TP9, TP21, TP22 | Keystone | Test Point, Compact, Orange, TH |
| 5122 | 8 | TP12, TP14, TP18, TP20, TP23, TP24, TP25, TP26 | Keystone | Test Point, Compact, Blue, TH |
| 5009 | 3 | TP13, TP15, TP16 | Keystone | Test Point, Compact, Yellow, TH |
| 5007 | 2 | TP17, TP19 | Keystone | Test Point, Compact, White, TH |
| MUX36D04IPWR | 1 | U1 | Texas Instruments | Fault-Protected, 8-Channel, Single-Ended and 4-Channel, Differential Multiplexer, PW0016A |



4.2 PCB Layout

Figure 2 and Figure 3 illustrate the EVM PCB layout.

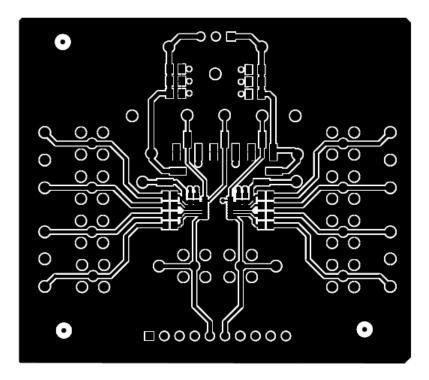


Figure 2. PCB Layer 1: Top Layer

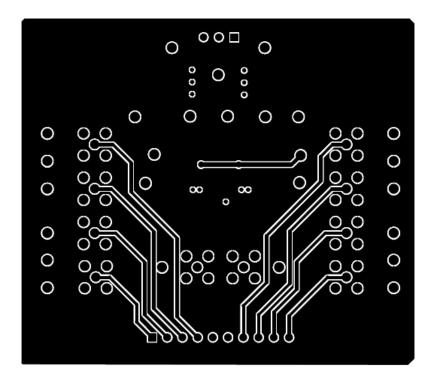


Figure 3. PCB Layer 2: GND Plane



4.3 Schematic

Figure 4 and Figure 5 show the EVM electrical and mechanical schematics, respectively.

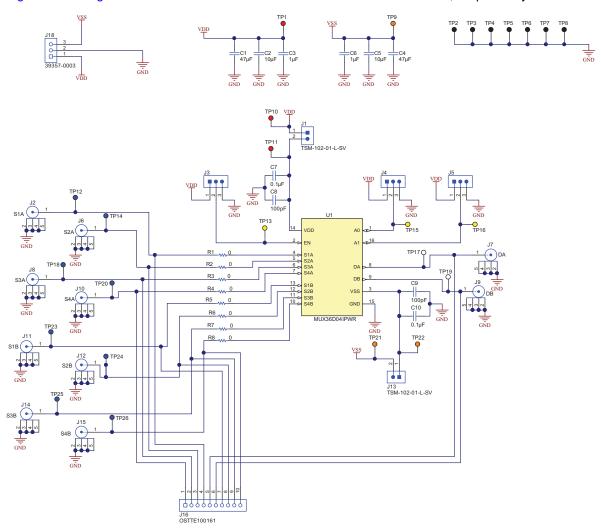


Figure 4. Schematic: Electrical



Figure 5. Schematic: Mechanical

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FCC Interference Statement for Class A EVM devices

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- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

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Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

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